SURFACE MOUNT

RF Transformer

TC9-1-75+

75Ω 0.3 to 475 MHz

TC9-1-75X+ Upgraded Version*

***Addition of Top Hat® Feature Benefits**
- Allows Faster Pick-and-Place
- Enables Visual Identification Marking

FEATURES
- Wideband, 0.3 to 475 MHz
- Good Return Loss, 23 dB Typ. in 1 dB Bandwidth
- Step-Down 9:1 Autotransformer
- Plastic Base with Leads
- Aqueous Washable

Generic photo used for illustration purposes only

CASE STYLE: AT224-1A

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS
- Matching Laser Diode

ELECTRICAL SPECIFICATIONS AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio (Primary/Secondary)			75/8		Ohms
Frequency Range		0.3		475	MHz
Insertion Loss[1]	0.3-475		3		dB
	0.5-450		2		
	0.9-370		1		

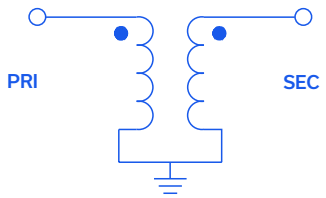
1. Insertion Loss is referenced to mid-band loss, 0.4 dB typ.
Stepdown, 75Ω primary, 51 pF across secondary.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-20°C to +85°C
Storage Temperature	-55°C to +100°C
RF Power	0.25 W
DC Current	30 mA

Permanent damage may occur if any of these limits are exceeded.

CONFIG. D



REV. E
ECO-025349
TC9-1-75+
MCL NY
250428

SURFACE MOUNT

RF Transformer

TC9-1-75+

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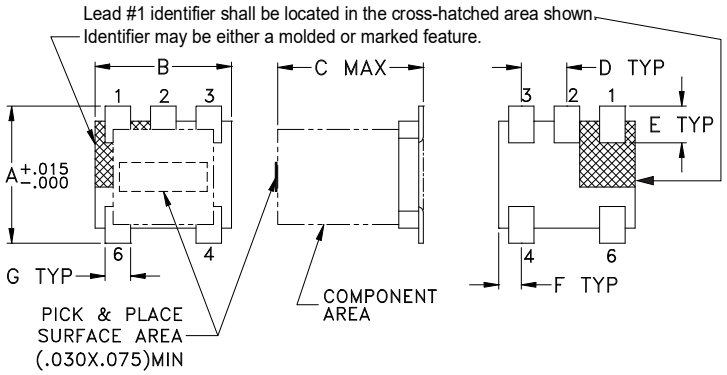
PIN CONNECTIONS

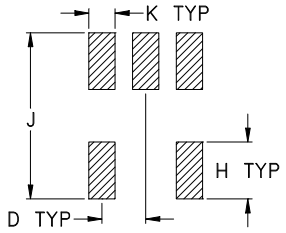
PRIMARY DOT	6
PRIMARY	3
SECONDARY DOT	1
SECONDARY	3

OUTLINE DRAWING



PRODUCT MARKING: N/A

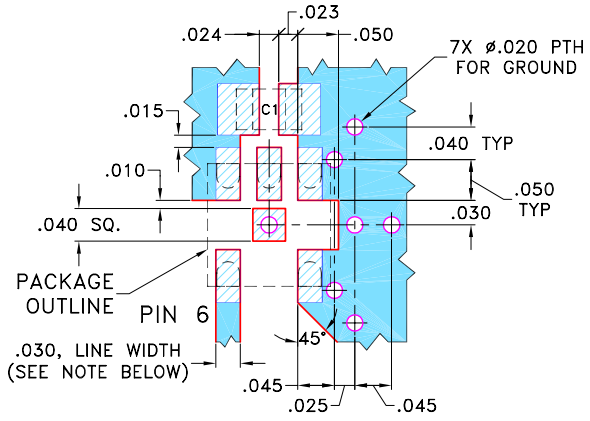
PCB Land Pattern



Suggested Layout,
Tolerance to be within±.002

DEMOBOARD MCL P/N: TB-TC9-1-75+

SUGGESTED PCB LAYOUT (PL-155)



CAPACITOR C1: 0805 SIZE, FOR VALUE SEE CATALOG.

NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DIMENSIONS (Inch / mm)

A	B	C	D	E	F
.150	.150	.160	.050	.040	.025
3.81	3.81	4.06	1.27	1.02	0.64

G	H	J	K		wt
.028	.065	.190	.030		grams
0.71	1.65	4.83	0.76		0.15

TAPE & REEL INFORMATION: F17

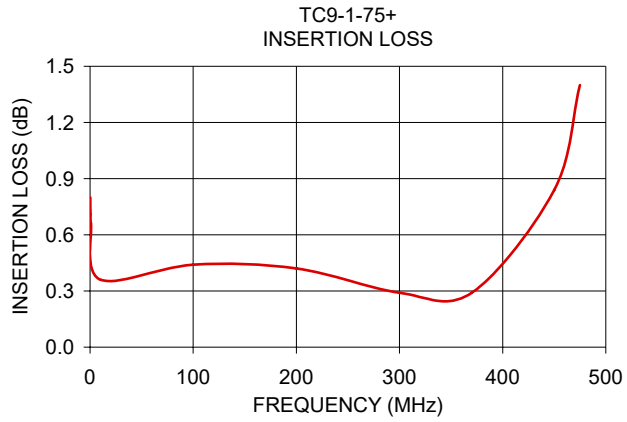
RF Transformer

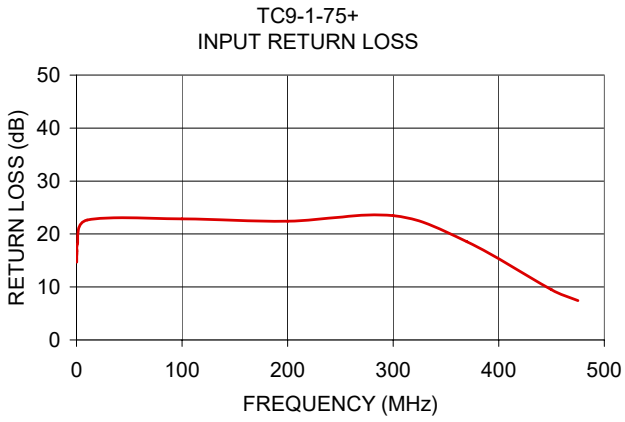
TC9-1-75+

75Ω 0.3 to 475 MHz

TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.30	0.80	14.70
0.50	0.71	16.80
0.90	0.66	18.13
10.00	0.36	22.63
100.00	0.44	22.86
200.00	0.42	22.40
300.00	0.29	23.48
370.00	0.29	18.53
450.00	0.84	9.48
475.00	1.40	7.44





NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

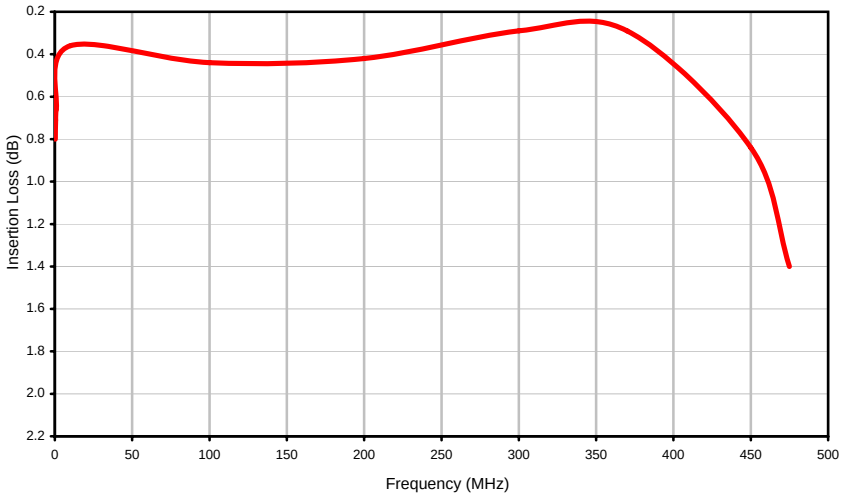
RF Transformer TC9-1-75+

Typical Performance Data

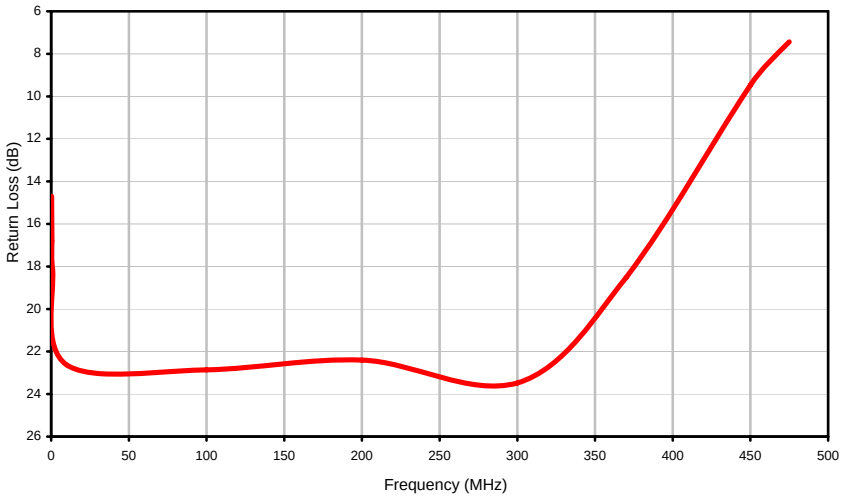
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.30	0.80	14.70
0.50	0.71	16.80
0.90	0.66	18.13
10.00	0.36	22.63
100.00	0.44	22.86
200.00	0.42	22.40
300.00	0.29	23.48
370.00	0.29	18.53
450.00	0.84	9.48
475.00	1.40	7.44

Typical Performance Curves

Insertion Loss



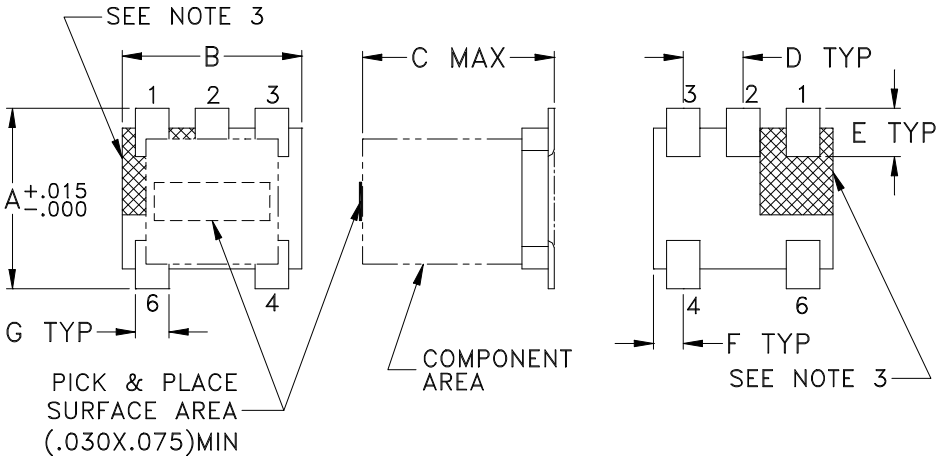
Return Loss



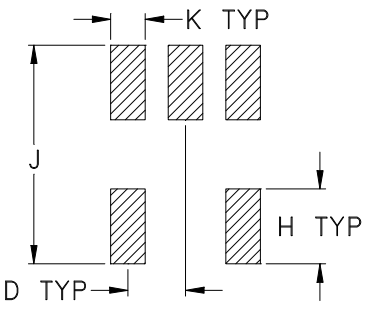
Case Style AT

Outline Dimensions

AT224-1A



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAMS
AT224-1A	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

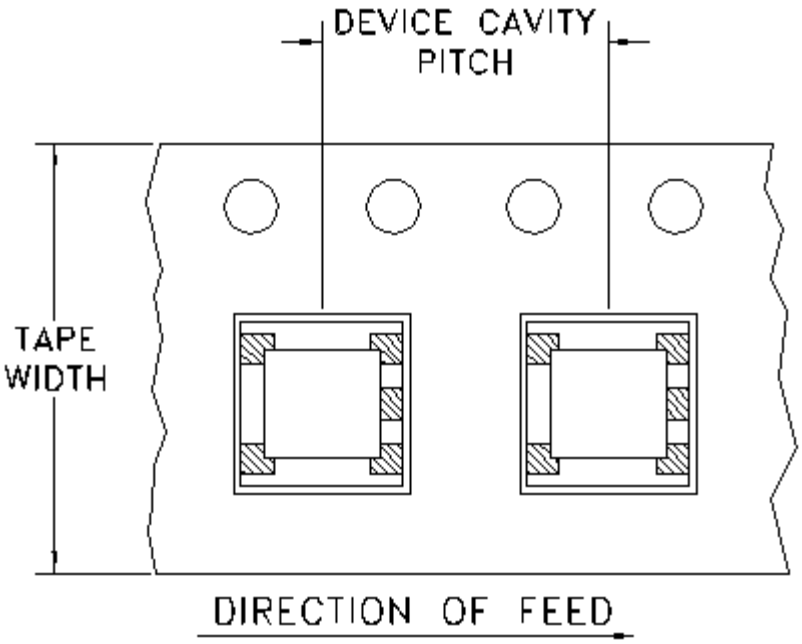
Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Case material: Plastic.
2. Termination finish:
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
3. Lead #1 identifier shall be located in the cross-hatched area shown.
   Identifier may be either a molded or marked feature.

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

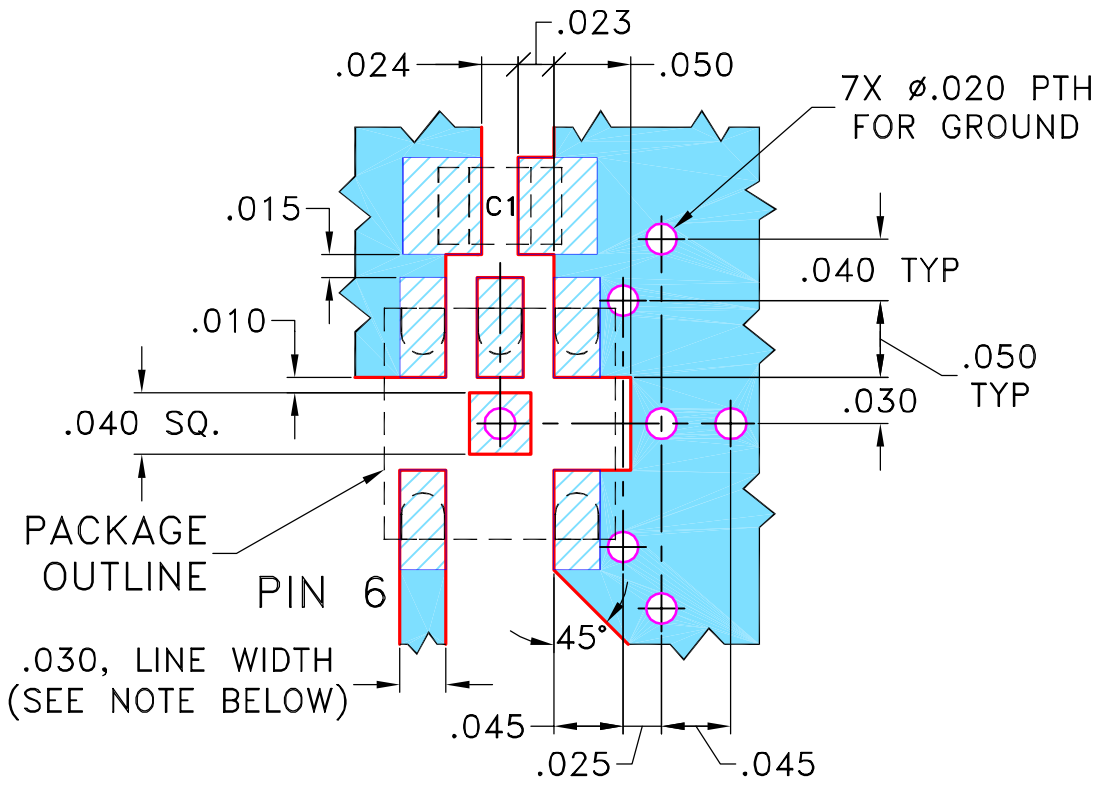
Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M91565	NEW RELEASE	04/16/04	AV	IG
A	M102713	ADDED "...WITH SMOBC"	01/12/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION
FOR AT224 CASE STYLE, "pp/kp" PIN CONNECTION



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DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	AV	03/23/04
TOLERANCES ON:	CHECKED	IL	04/16/04
2 PL DECIMALS ±	APPROVED	IG	04/16/04
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

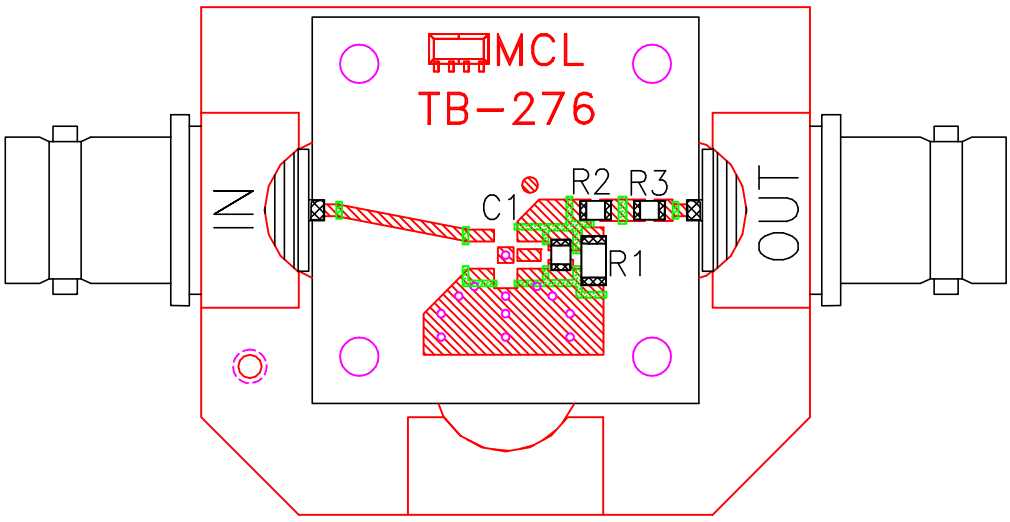
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, pp/kp, 75, AT224, TC9, TB-276

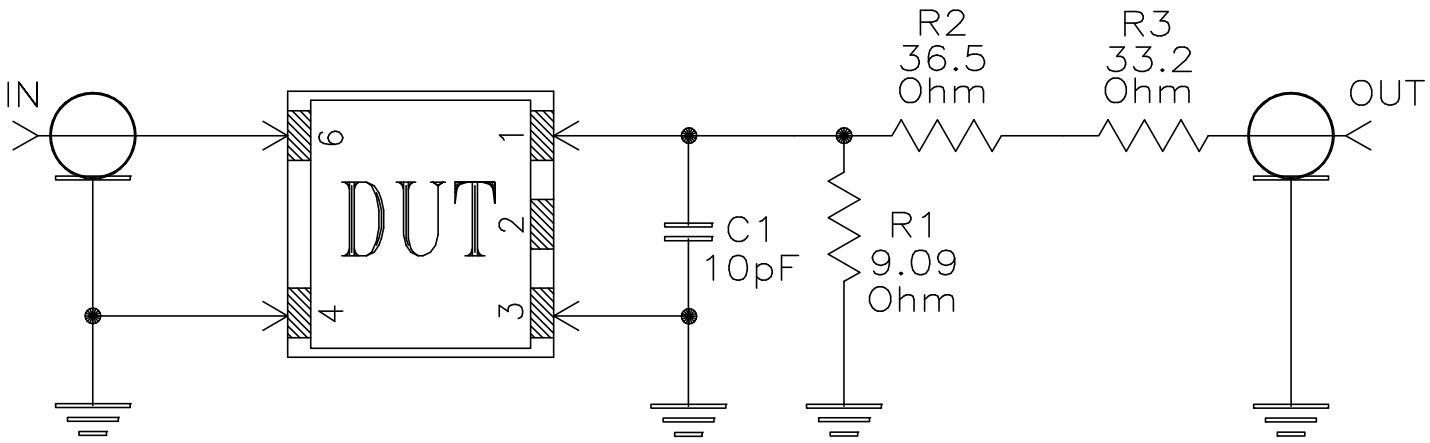
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-155	A

FILE:	SCALE:	SHEET:
98PL155	8:1	1 OF 1

Evaluation Board and Circuit



TB-276



Schematic Diagram

Notes:

1. BNC Female connectors.
2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

Mini-Circuits®

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Environmental Specifications ENV02

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215